

## FQPF9N50CF N-Channel QFET® FRFET® MOSFET

### 500 V, 9 A, 850 mΩ

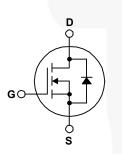
### Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and • Fast Recovery Body Diode (Typ. 100 ns) electronic lamp ballasts.

### Features

- 9 A, 500 V, R<sub>DS(on)</sub> = 850 mΩ (Max.) @ V<sub>GS</sub> = 10 V, I<sub>D</sub> = 4.5 A
- Low Gate Charge (Typ. 28 nC)
- Low Crss (Typ. 24 pF)
- 100% Avalanche Tested





### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FQPF9N50CF	Unit	
V <sub>DSS</sub>	Drain-Source Voltage		500	V	
I <sub>D</sub>	Drain Current - Continuous ( $T_c = 25^{\circ}C$ )		9*	А	
	- Continuous (T <sub>C</sub> = 100°C)		5.4*	А	
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	36*	A	
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	360	mJ	
I <sub>AR</sub>	Avalanche Current	(Note 1)	9	А	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	4.4	mJ	
dv/dt	Peak Diode Recovery dv/dt (Not		4.5	V/ns	
P <sub>D</sub>	Power Dissipation ( $T_C = 25^{\circ}C$ )		44	W	
	- Derate above 25°C		0.35	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.		300	°C	

\* Drain current limited by maximum junction temperature

### **Thermal Characteristics**

Symbol	Parameter	FQPF9N50CF	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	2.86	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/VV	

December 2013

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQPF9N50CF	FQPF9N50CF	TO-220F	Tube	N/A	N/A	50 units

### Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics			Į	Į	4
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A	500			V
$\Delta BV_{DSS}$ / $\Delta T_{J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		0.57		V/°C
I <sub>DSS</sub> Zero (	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V			10	μA
		V <sub>DS</sub> = 400 V, T <sub>C</sub> = 125°C			100	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30 V, V <sub>DS</sub> = 0 V			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS}$ = -30 V, $V_{DS}$ = 0 V			-100	nA
On Charac	teristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.0		4.0	
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 4.5 A		0.70	0.85	Ω
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 4.5 A		6.5		S
Dynamic C	haracteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V,$		790	1030	p₽
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		130	170	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			24	30	pF
Switching (	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 250 V, I <sub>D</sub> = 9A,		18	45	ns
t <sub>r</sub>	Turn-On Rise Time	$R_{G} = 25 \Omega$		65	140	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			93	195	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)		64	125	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 9A,		28	35	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V	-	4		nC
Q <sub>gd</sub>	Gate-Drain Charge	(Note 4)	7	15		nC
Drain-Sour	ce Diode Characteristics and Maximum Ratings	5			1	
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current				9*	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current				36*	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 9 A			1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 9 A,		100	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs		0.3		μC

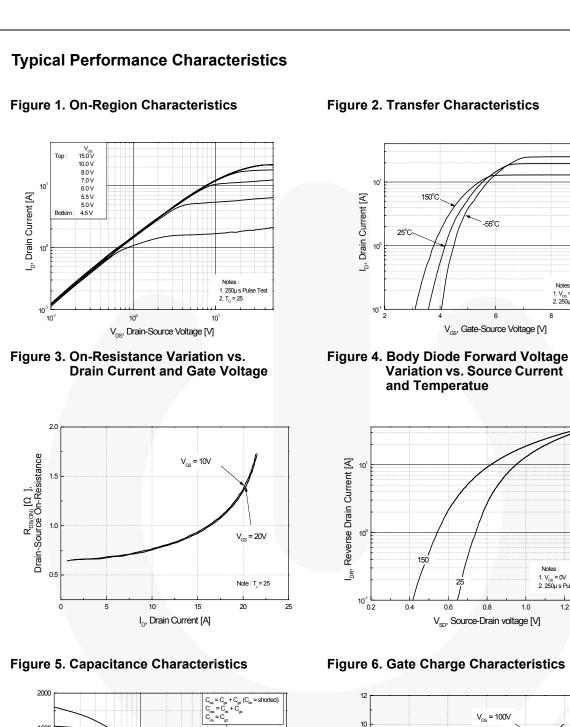
#### NOTES:

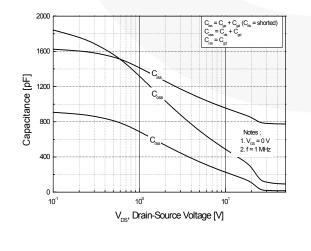
1. Repetitive rating : pulse-width limited by maximum junction temperature.

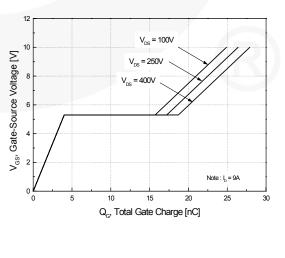
2. L = 8 mH, I<sub>AS</sub> = 9 A, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , starting T<sub>J</sub> = 25°C.

3. I\_{SD} \leq 11 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS,} Starting ~T\_J = 25°C.

4. Essentially independent of operating temperature.







0.8

-55°C

Notes : 1. V<sub>DS</sub> = 40V 2. 250µ s Pulse Test

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Notes :

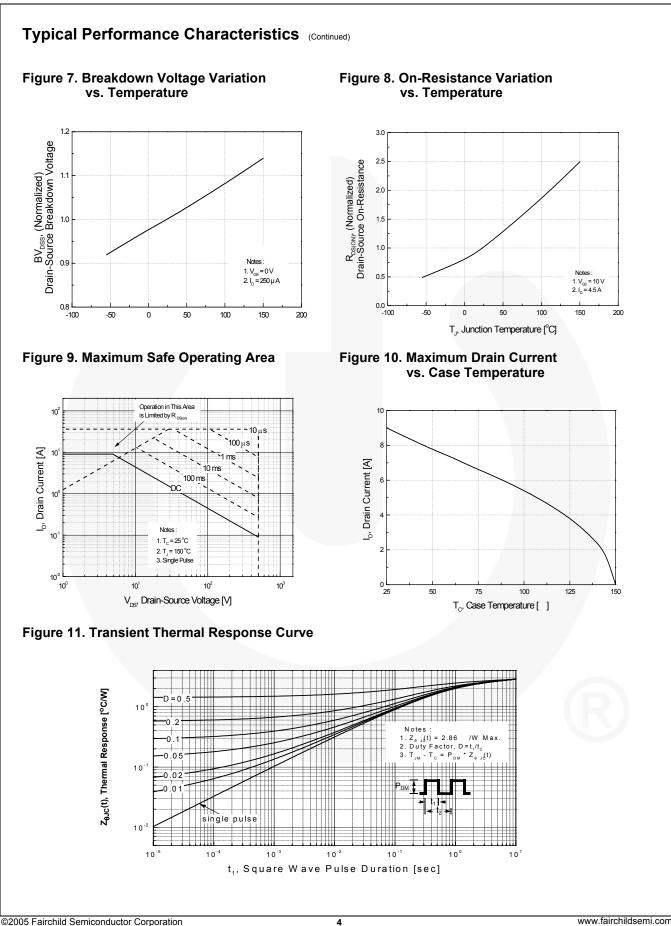
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1. V<sub>GS</sub> = 0V 2. 250µ s Pulse Test

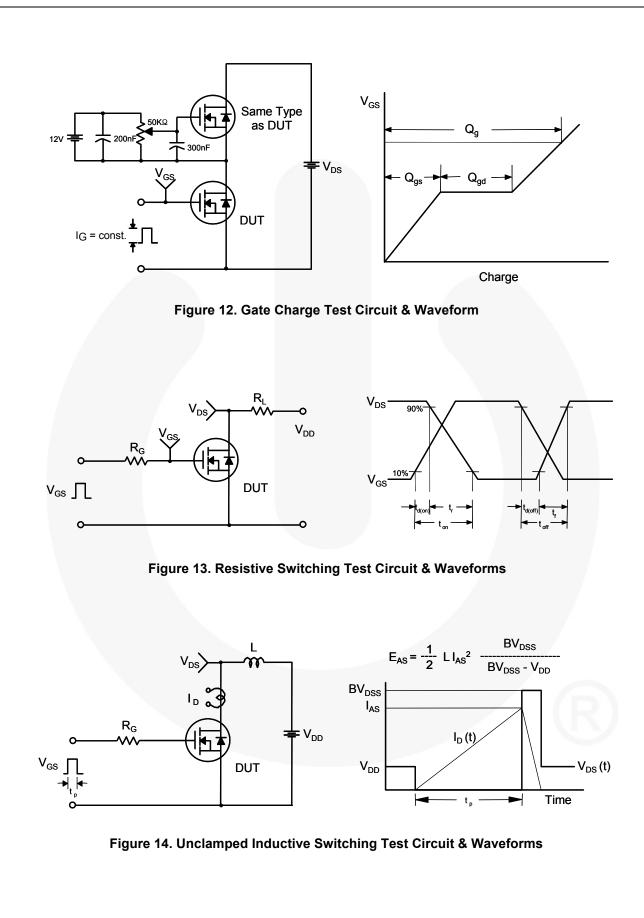
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1.4

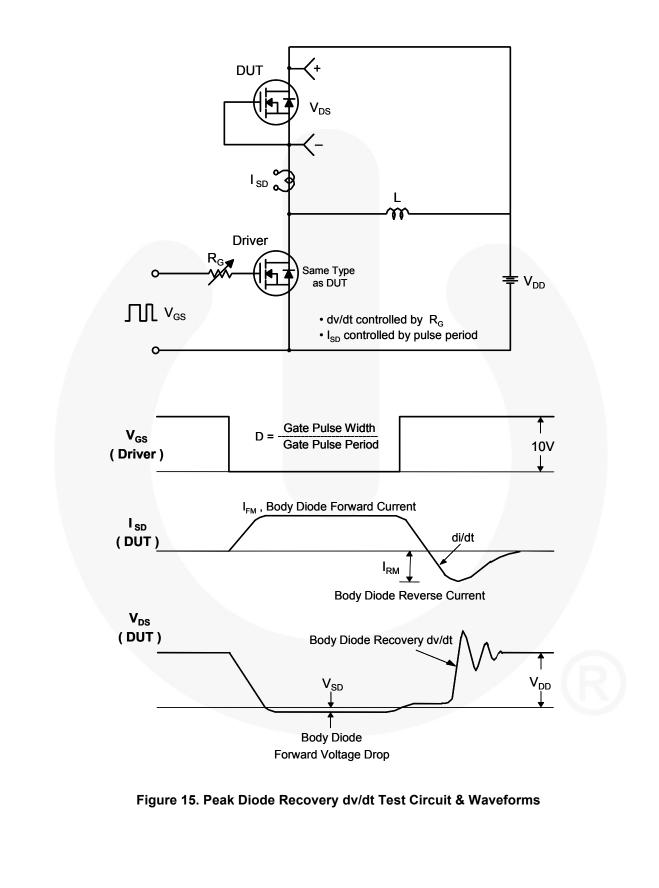
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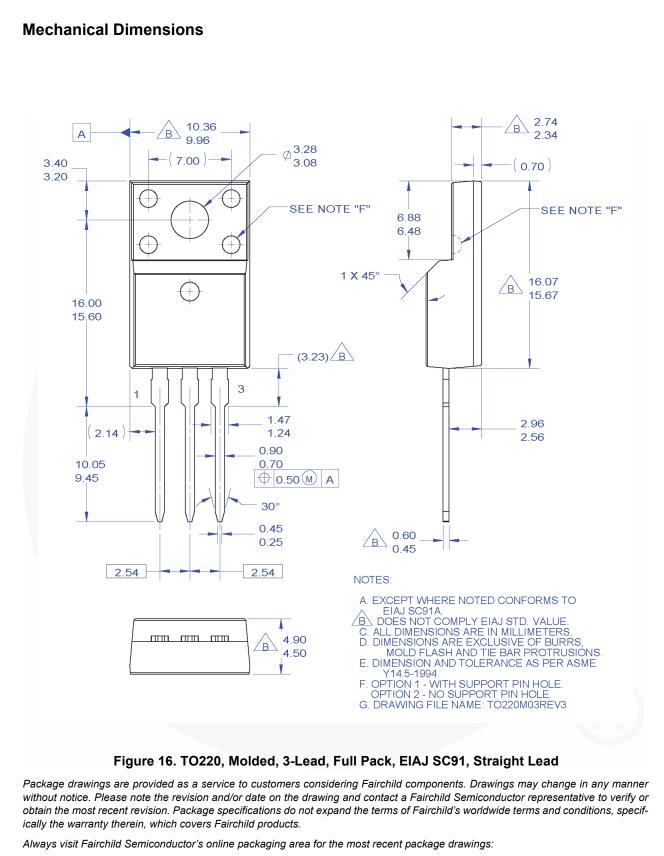


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FQPF9N50CF — N-Channel QFET® FRFET® MOSFET





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